



SURFACE MOUNT DATALINE PROTECTION DEVICE

Features

- 300 Watts Peak Pulse Power (t_P = 8 × 20μs)
- Transient Protection for Data Line to IEC61000-4-2 Level 4 (ESD), 8kV HBM

Contact: Discharge – ±30kV Air: Discharge – ±30kV

- IEC 61000-4-4 (EFT)
- Low Leakage Current
- Surface Mount Package Ideally Suited for Automated Insertion
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

Package: SOT23

 Package Material: Molded Plastic. UL Flammability Classification Rating 94V-0

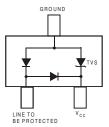
• Moisture Sensitivity: Level 1 per J-STD-020

Terminals: Solderable per MIL-STD-202, Method 208
Lead Free Plating (Matte Tin Finish Annealed over Alloy 42
Leadframe) (3)

Terminal Connections: See Diagram
Marking Information: See Page 1
Ordering Information: See Page 1
Weight: 0.008 grams (Approximate)







Device Schematic

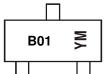
Ordering Information (Note 4)

Part Number	Packago	Packing	
rait Nullibei	Package	Qty.	Carrier
DLPT05A-7	SOT23	3000	Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.
- 5. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.

Marking Information



B01 = Product Type Marking Code

YM = Date Code Marking

Y = Year (ex: J = 2022)

M = Month (ex: 9 = September)

Date Code Key

Vace	0000	0000	0004	0005	0000	0007	0000	0000	0000	0004	0000	0000
Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	J	K	L	M	N	0	Р	R	S	T	U	V
	T			ı	ı	ı			1	1	l	
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Pulse Power ($t_P = 8 \times 20 \mu s$, per Figure 2)	P _{PK}	300	W
Peak Forward Voltage (IPP = 1A, tP = 8 × 20µs, per Figure 2)	V _{FP}	2.1	V
Diode Peak Repetitive Reverse Voltage	V _{RRM}	75	V

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 10)	Reja	417	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Reverse Standoff Voltage		n Voltage @ I _T	Test Current	Max. Reverse Leakage @ V _{RWM} (Note 9)	Max. Clamping Voltage @ IPP = 1A (Note 8)	Typical Peak Pulse Current (Note 7)	Typical Total Capacitance (Note 6)
V _{RWM} (V)	Min (V)	Max (V)	I _T (mA)	I _R (μ A)	V _C (V)	(A)	(pF)
5	6.0	_	1.0	20	9.8	17	1.9

Notes:

^{6.} $V_R = 0V$, f = 1MHz from line to be protected to ground pin.

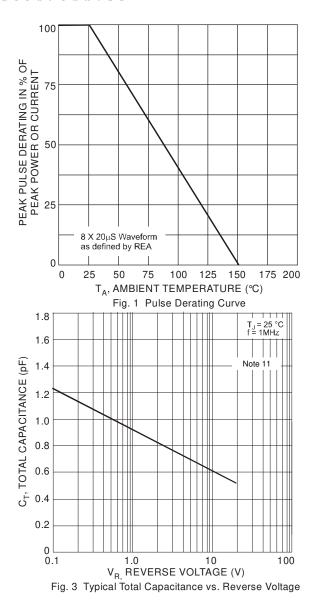
^{7.} $t_P = 8 \times 20 \mu s$.

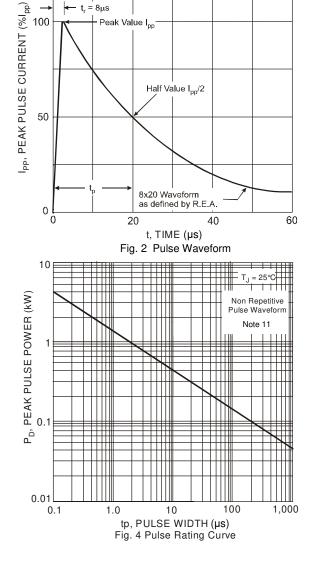
^{8.} Clamping voltage value is based on an 8×20µs peak pulse current (IPP) waveform.

^{9.} Short duration pulse test used to minimize self-heating effect.

^{10.} Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.



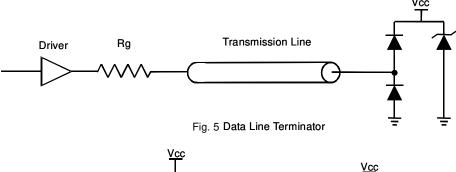




Note: 11. Measured from line to be protected to ground pin.



Typical Application Schematics



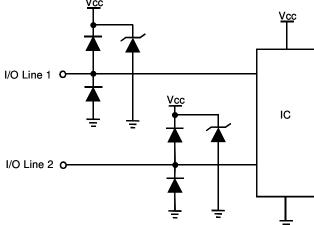


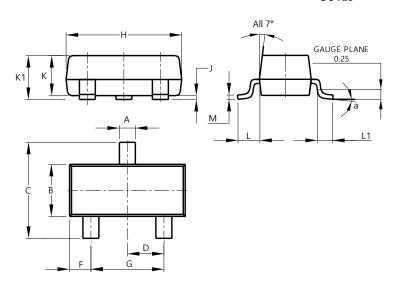
Fig. 6 Data Line Protection



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

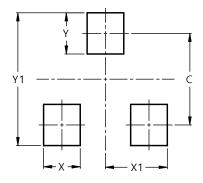


SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Η	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
X	0.8
X1	1.35
Υ	0.9
Y1	2.9



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